

BSE Sensor Board		Team Phantom	
Project: BSE_SCH.SchDoc		[No Variations]	
Units: Mils	DWG NO: -		Revision: 1.0
Date: 9/2/2020		Sheet 1	of 1

BSE Rev1.0

Team Phantom

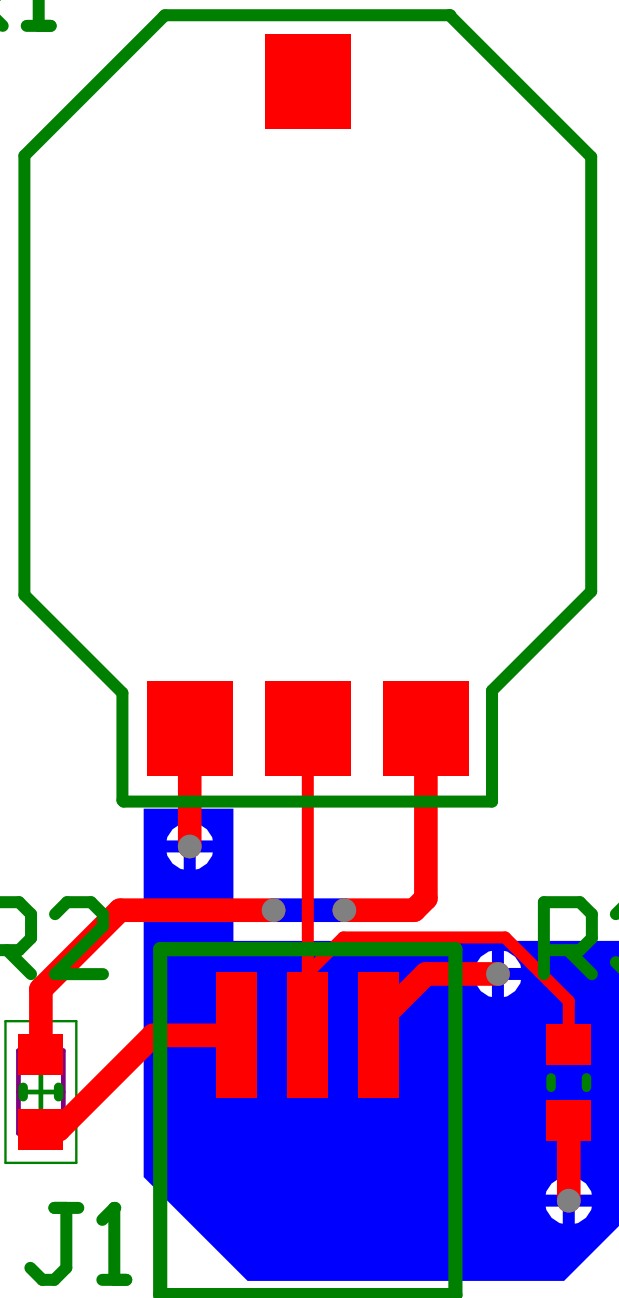
R1

Jay Pacamarra

R2

R3

J1



Boards

Bill of Materials

Bill of Materials For Project [BSE_Project.PrjPCB] (No PCB Document Selected)

Source Data From:	<u>BSE_Project.PrjPCB</u>
Project:	<u>BSE_Project.PrjPCB</u>
Variant:	<u>None</u>

Creation Date:	<u>9/2/2020</u>	<u>12:29:40 AM</u>
Print Date:	<u>02-Sep-20</u>	<u>12:29:44 AM</u>
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Footprint	Comment	LibRef	Designator	Description	Quantity
Header3POS-SMD	Sensor Header	Header3POS-SMD	J1	Conn Shrouded Header (4 Sides) HDR 3 POS 1.5mm Solder RA SMD Pico-SPOX™ T/R	1
10k Rotary Encoder	10k pot	10k rotary encoder	R1	Res Cermet Trimmer 10K Ohm 30% 1(Elec)/1(Mech)Turn 4mm (11 X 14.9 X 3.1mm) Gull Wing SMD T/R	1
RES 0603	1.1k	RES 1.1k	R2	ERJPA3 Resistors 0.25W 0603 1K1 1%	1
RES 0603	2M	RES 2M	R3	Res Thick Film 0603 2MegaOhm 1% 1/4W ±100ppm/K Molded Paper T/R	1

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Approved	Notes

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